



DOCKET:

TBMF100398000

**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**INVENTOR:** 

Todd H. Buley

**EXAMINER:** 

**SERIAL NO.:** 

10/605,257

ART UNIT:

1*7*25

**FILING DATE:** 

September 18, 2003

DATE:

May 6, 2005

FOR:

Inclined Wave Solder Methodology for Wave Soldering Double Sided

Pin-in-Hole Components)

## **STATUS INQUIRY REQUEST**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Applicant respectfully inquires about the status of the subject application. To date, no office action has been received since the filing of the application on September 18, 2003. Upon checking the May 3, 2005, Volume 1294, Number 1 of the Electronic Official Gazette for Patents, we find that the average filing date of applications receiving a first office action in the last three months is November 13, 2003.

A duplicate copy of this request is enclosed.

Respectfully submitted

Peter W. Peterson Reg. No. 31,867

**DeLIO & PETERSON, LLC** 121 Whitney Avenue New Haven, CT 06510-1241

(203) 787-0595

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service on the date indicated below as first class mail in an envelope addressed to the Assistant Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Name:	Brenda Sullivan	Date:	5/6/05	Signature:	B	Un	Ne	Xall	[[NAS	$\wedge$